# **FFPF10F150S**

# 10 A, 1500 V, Damper Diode

#### **Features**

- High Speed Recovery  $t_{RR} = 170 \text{ ns } (@ I_F = 1 \text{ A})$
- Max Forward Voltage,  $V_F = 1.6 \text{ V}$  (@  $T_C = 25^{\circ}\text{C}$ )
- 1500 V Reverse Voltage and High Reliability
- Low Forward Voltage
- This Device is Pb-Free and is RoHS Compliant

# **Applications**

• Suitable for Damper Diode in Horizontal Deflection Circuits

# **ABSOLUTE MAXIMUM RATINGS**

 $T_C = 25^{\circ}C$  unless otherwise noted

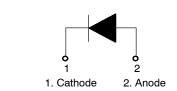
Symbol	Parameter	Rating	Unit	
VRRM	Peak Repetitive Reverse Voltage	1500	V	
VRWM	Working Peak Reverse Voltage 1500			
IF(AV)	Average Rectified Forward Current @ $T_C = 125^{\circ}C$	rward Current 10		
IFSM	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	100	Α	
ТJ, Tsтg	Operating Junction and Storage Temperature	- 65 to +175	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



# ON Semiconductor®

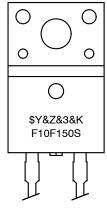
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TO-220, 2-Lead CASE 221AS

# **MARKING DIAGRAM**



\$Y = ON Semiconductor Logo &Z&3 = Data Code (Year & Week)

&K = Lot

F10F150S = Specific Device Code

# **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

#### **FFPF10F150S**

# THERMAL CHARACTERISTICS $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Max.	Unit
Rejc	Maximum Thermal Resistance, Junction to Case	3.0	°C/W

# PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFPF10F150STU	F10F150S	TO-220F-2L	Tube	N/A	N/A	30

# **ELECTRICAL CHARACTERISTICS** $T_C = 25^{\circ}C$ unless otherwise noted

Parameter	Conditions		Min.	Тур.	Max.	Unit
V <sub>F</sub> (Note 1)	Maximum Instantaneous Forward Voltage I <sub>F</sub> = 10 A I <sub>F</sub> = 10 A	T <sub>C</sub> = 25°C T <sub>C</sub> = 125°C	_ _	- -	1.6 1.4	٧
I <sub>R</sub> (Note 1)	Maximum Instantaneous Reverse Current @ rated V <sub>R</sub>	T <sub>C</sub> = 25°C T <sub>C</sub> = 125°C	- -	- -	10 80	μΑ
t <sub>RR</sub>	Maximum Reverse Recovery Time ( $I_F = 1 \text{ A}, di_F/dt = 50 \text{ A}/\mu\text{s}, V_R = 30 \text{ V}$ )		_	_	170	ns
t <sub>FR</sub>	Maximum Forward Recovery Time (I <sub>F</sub> = 6.5 A, di <sub>F</sub> /dt = 50 A/ $\mu$ s)		_	_	250	ns
$V_{FRM}$	Maximum Forward Recovery Voltage		-	-	14	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# **Test Circuit and Waveforms**

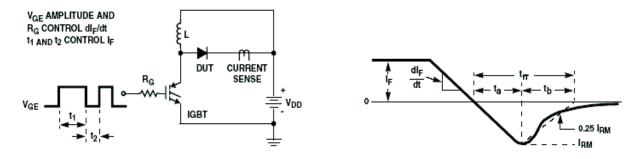


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

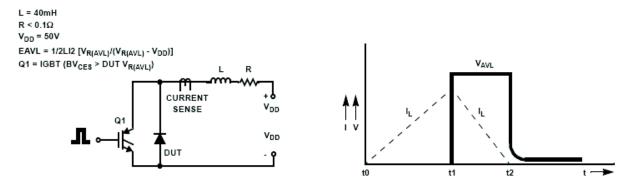
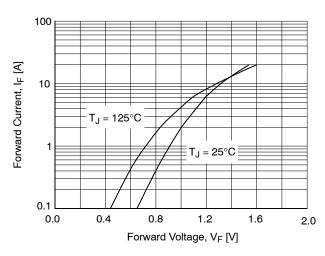


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

<sup>1.</sup> Pulse: Test Pulse Width = 300 μs, Duty Cycle = 2%

# **FFPF10F150S**

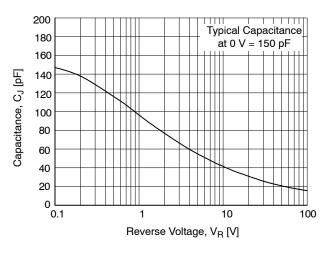
# **TYPICAL CHARACTERISTICS**



100 10 Reverse Current, IR [µA] T<sub>J</sub> = 125°C  $T_J = 100^{\circ}C$ 0.1 T<sub>J</sub> = 25°C 0.01 0.001 0 300 600 900 1200 1500 Reverse Voltage, V<sub>R</sub> [V]

Figure 3. Typical Forward Voltage Drop

**Figure 4. Typical Reverse Current** 



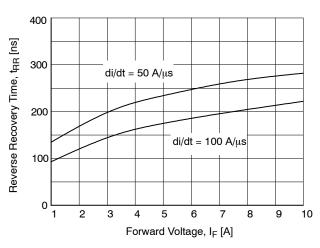
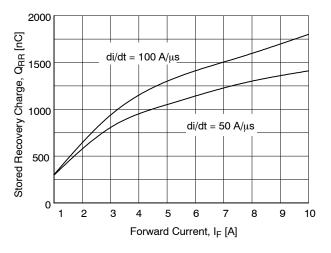


Figure 5. Typical Junction Capacitance

Figure 6. Typical Reverse Recovery Time



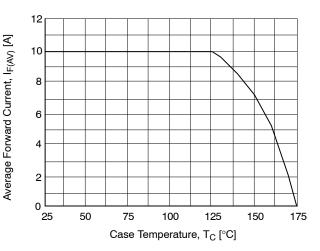
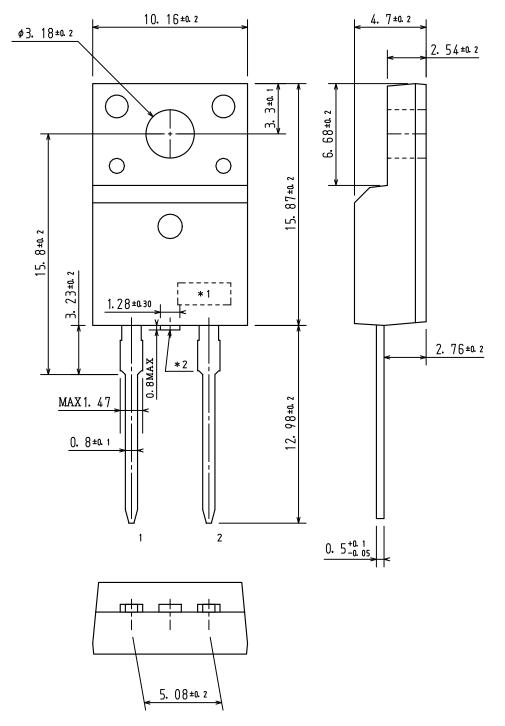


Figure 7. Typical Stored Charge

Figure 8. Forward Current Deration Curve

# TO-220 Fullpack, 2-Lead / TO-220F-2FS CASE 221AS ISSUE O

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